

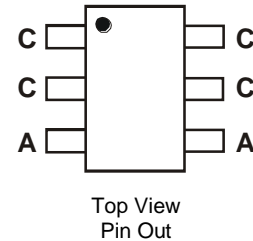
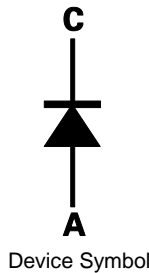
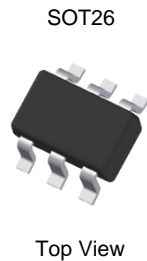
Product Summary

| V_{RRM} (V) | I_o (A) | V_F Max (V) @ +25°C | I_R Max (μ A) @ 30V +25°C |
|---------------|-----------|--------------------------|-------------------------------------|
| 40 | 2 | 0.54 | 40 |

Description and Applications

A surface mount Schottky Barrier Diode featuring low forward voltage drop suitable for high frequency rectification and reverse voltage protection.

- DC-DC Converters
- Strobes
- Mobile Phones
- Charging Circuits
- Motor Control



Features and Benefits

- Low Equivalent On Resistance
- Extremely Low Leakage
- Low V_F , Fast Switching Schottky
- Package Thermally Rated to +150°C
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

Mechanical Data

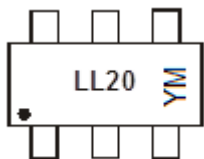
- Case: SOT26
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe; (Lead-Free Plating) Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.016 grams (Approximate)

Ordering Information (Note 5)

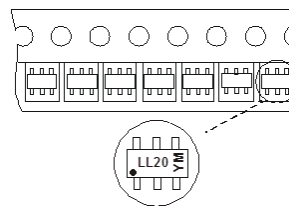
| Part Number | Package | Shipping |
|-------------|---------|--------------------|
| ZLLS2000QTA | SOT26 | 3,000/Tape & Reel |
| ZLLS2000QTC | SOT26 | 10,000/Tape & Reel |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to <https://www.diodes.com/quality/>.
 5. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



LL20 = Product Type Marking Code
 YM = Date Code Marking
 Y or \bar{Y} = Year (ex: G = 2019)
 M or \bar{M} = Month (ex: 9 = September)



Date Code Key

| Year | 2016 | 2017 | 2018 | 2019 | 2020 | 2021 | 2022 | 2023 | 2024 | 2025 | 2026 | |
|-------|------|------|------|------|------|------|------|------|------|------|------|-----|
| Code | D | E | F | G | H | I | J | K | L | M | N | |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | O | N | D |

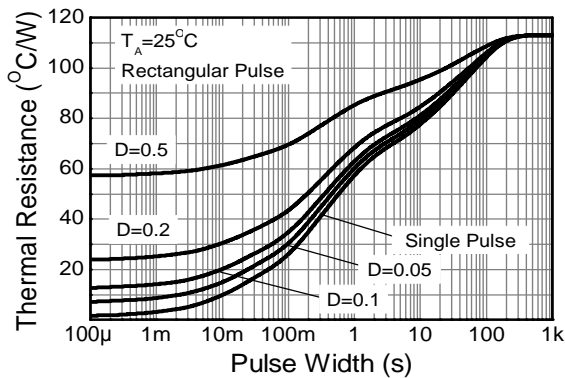
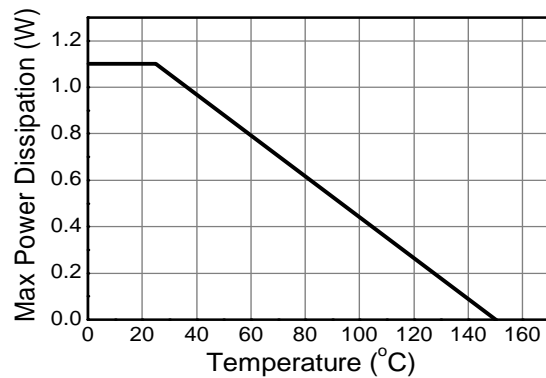
Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|---|-----------|-------|------|
| Continuous Reverse Voltage | V_{RRM} | 40 | V |
| Forward Current | I_F | 2.2 | A |
| Peak Repetitive Forward Current Rectangular Pulse Duty Cycle | I_{FPK} | 3.55 | A |
| Non Repetitive Forward Current | I_{FSM} | 12 | A |

Thermal Characteristics

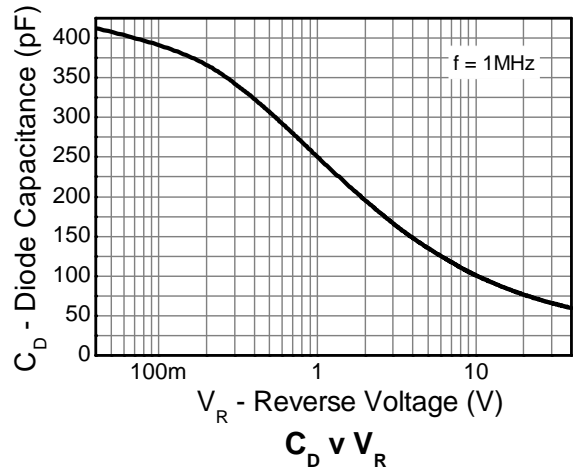
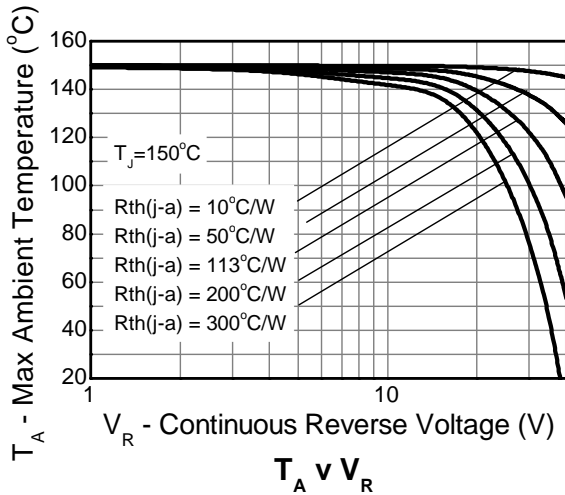
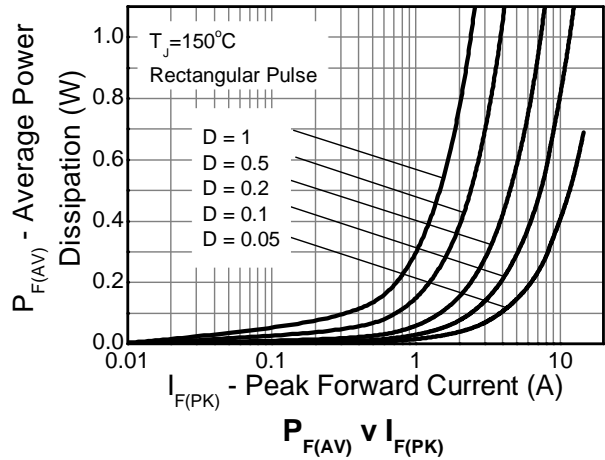
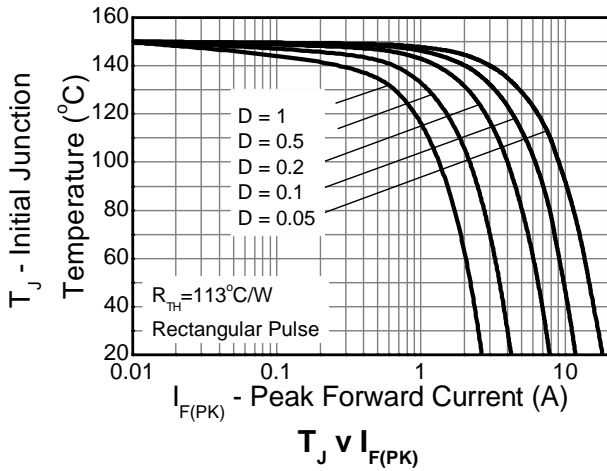
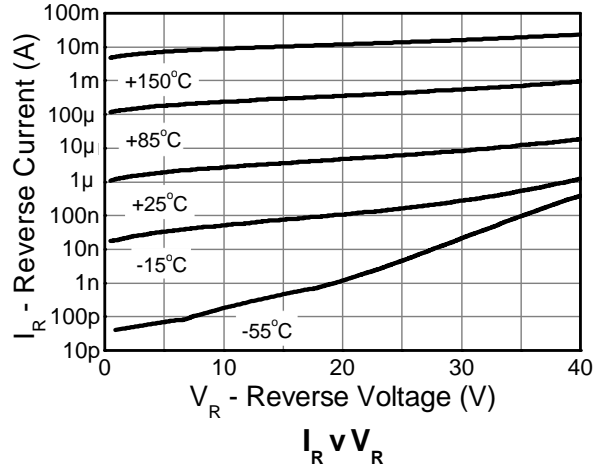
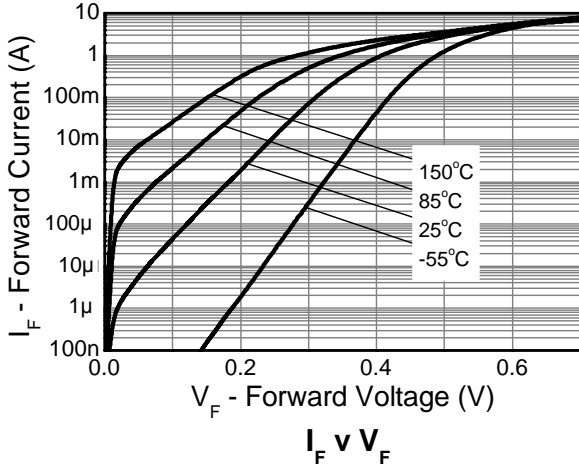
| Characteristic | Symbol | Value | Unit |
|---|-----------------|-------------|--------------------|
| Power Dissipation @ $T_A = +25^\circ\text{C}$ | | 1.1 | W |
| Single Die Continuous | P_D | 1.71 | W |
| Single Die Measured at $t < 5s$ | | | |
| Junction to Ambient (Note 6) | $R_{\theta JA}$ | 113 | $^\circ\text{C/W}$ |
| Junction to Ambient (Note 7) | $R_{\theta JA}$ | 73 | $^\circ\text{C/W}$ |
| Storage Temperature Range | T_{STG} | -55 to +150 | $^\circ\text{C}$ |
| Junction Temperature | T_J | +150 | $^\circ\text{C}$ |

Notes: 6. For a device surface mounted on 25mm × 25mm FR-4 PCB with high coverage of single sided 1oz copper, in still air conditions.
7. For a device mounted on FR-B PCB measured at $t < 5s$.


Transient Thermal Impedance

Derating Curve
Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|---------------------------|-------------|-----|-----|-----|---------------|---|
| Reverse Breakdown Voltage | $V_{(BR)R}$ | 40 | — | — | V | $I_R = 1\text{mA}$ |
| Forward Voltage (Note 8) | V_F | — | 285 | — | mV | $I_F = 50\text{mA}$ |
| | | — | 305 | — | | $I_F = 100\text{mA}$ |
| | | — | 335 | — | | $I_F = 250\text{mA}$ |
| | | — | 365 | 390 | | $I_F = 500\text{mA}$ |
| | | — | 403 | 430 | | $I_F = 1\text{A}$ |
| | | — | 433 | 490 | | $I_F = 1.5\text{A}$ |
| | | — | 461 | 540 | | $I_F = 2\text{A}$ |
| | | — | 509 | 600 | | $I_F = 3\text{A}$ |
| Reverse Current | I_R | — | 10 | 40 | μA | $V_R = 30\text{V}$ |
| | | — | 0.6 | — | mA | $V_R = 30\text{V}, T_A = +85^\circ\text{C}$ |
| Diode Capacitance | C_D | — | 65 | — | pF | $f = 1\text{MHz}, V_R = 30\text{V}$ |
| Reverse Recovery Time | t_{RR} | — | 6 | — | ns | $I_F = 0.5\text{A}, I_R = 1.0\text{A}, I_{RR} = 0.25\text{A}$ |

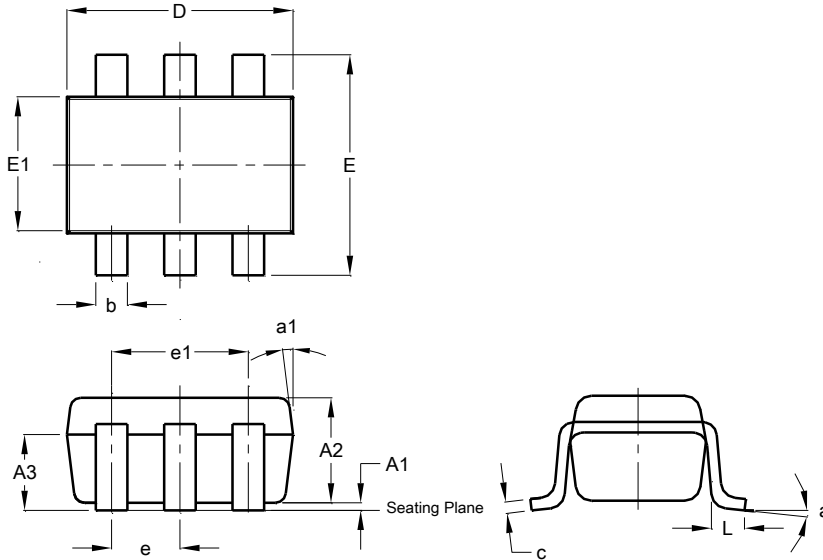
Note: 8. Measured under pulsed conditions. Pulse width = 300 μs . Duty cycle < 2%.



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT26

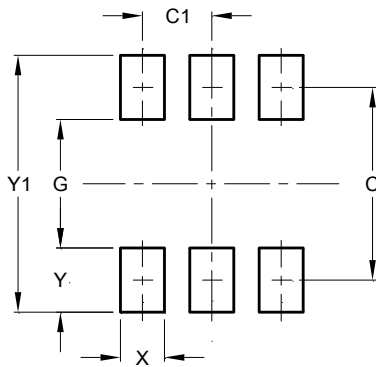


| SOT26 | | | |
|-----------------------------|-------|------|------|
| Dim | Min | Max | Typ |
| A1 | 0.013 | 0.10 | 0.05 |
| A2 | 1.00 | 1.30 | 1.10 |
| A3 | 0.70 | 0.80 | 0.75 |
| b | 0.35 | 0.50 | 0.38 |
| c | 0.10 | 0.20 | 0.15 |
| D | 2.90 | 3.10 | 3.00 |
| e | - | - | 0.95 |
| e1 | - | - | 1.90 |
| E | 2.70 | 3.00 | 2.80 |
| E1 | 1.50 | 1.70 | 1.60 |
| L | 0.35 | 0.55 | 0.40 |
| a | - | - | 8° |
| a1 | - | - | 7° |
| All Dimensions in mm | | | |

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT26



| Dimensions | Value (in mm) |
|------------|---------------|
| C | 2.40 |
| C1 | 0.95 |
| G | 1.60 |
| X | 0.55 |
| Y | 0.80 |
| Y1 | 3.20 |

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